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## Silicon N-Channel MOS FET



ADE-208-1267 (Z) 1st. Edition Mar. 2001

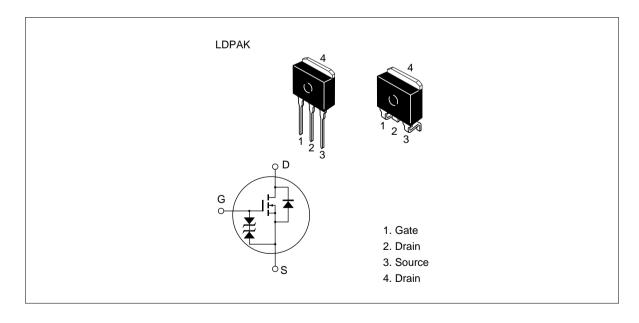
#### **Application**

High speed power switching

#### **Features**

- Low on-resistance
- High speed switching
- Low drive current
- · No secondary breakdown
- Suitable for switching regulator, DC-DC converter and motor driver

#### **Outline**



## **Absolute Maximum Ratings** (Ta = 25°C)

Item		Symbol	Ratings	Unit
Drain to source voltage	2SK1315	V <sub>DSS</sub>	450	V
	2SK1316		500	
Gate to source voltage		V <sub>GSS</sub>	±30	V
Drain current		I <sub>D</sub>	8	A
Drain peak current		l <sub>D(pulse)</sub> *1	32	Α
Body to drain diode reverse drain current		I <sub>DR</sub>	8	Α
Channel dissipation		Pch*2	60	W
Channel temperature		Tch	150	°C
Storage temperature		Tstg	-55 to +150	°C

Notes: 1. PW  $\leq$  10  $\mu$ s, duty cycle  $\leq$  1%

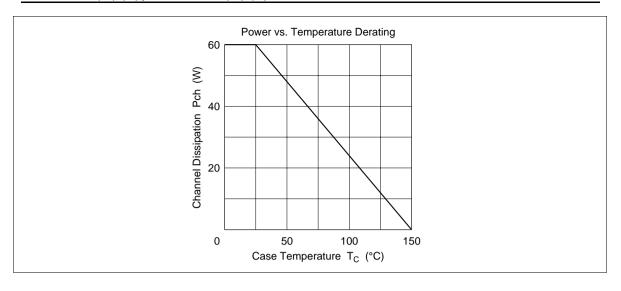
2. Value at  $T_c = 25^{\circ}C$ 

## **Electrical Characteristics** (Ta = 25°C)

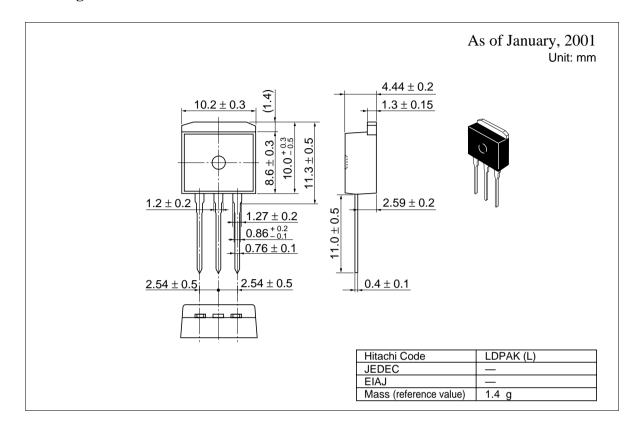
Symbol	Min	Тур	Max	Unit	Test conditions
V <sub>(BR)DSS</sub>	450	_	_	V	$I_D = 10 \text{ mA}, V_{GS} = 0$
<del>-</del> 3	500				
$V_{(BR)GSS}$	±30	_	_	V	$I_{G} = \pm 100 \ \mu A, \ V_{DS} = 0$
I <sub>GSS</sub>	_	_	±10	μΑ	$V_{GS} = \pm 25 \text{ V}, V_{DS} = 0$
i I <sub>DSS</sub>	_	_	250	μΑ	$V_{DS} = 360 \text{ V}, V_{GS} = 0$
5					$V_{DS} = 400 \text{ V}, V_{GS} = 0$
$V_{\rm GS(off)}$	2.0	_	3.0	V	$I_{D} = 1 \text{ mA}, V_{DS} = 10 \text{ V}$
S R <sub>DS(on)</sub>	_	0.55	0.7	Ω	$I_D = 4 \text{ A}, V_{GS} = 10 \text{ V}^{*1}$
<del>-</del> 3	_	0.60	8.0		
yfs	4.5	7.5	_	S	$I_D = 4 \text{ A}, V_{DS} = 10 \text{ V}^{*1}$
Ciss	_	1150	_	pF	$V_{DS} = 10 \text{ V}, V_{GS} = 0,$
Coss	_	340	_	pF	f = 1 MHz
Crss	_	55	_	pF	
t <sub>d(on)</sub>	_	17	_	ns	$I_D = 4 A, V_{GS} = 10 V,$
t <sub>r</sub>	_	55	_	ns	$R_L = 7.5 \Omega$
t <sub>d(off)</sub>	_	100	_	ns	
t <sub>f</sub>	_	45	_	ns	<del>_</del>
$V_{DF}$	_	0.9	_	V	$I_F = 8 A, V_{GS} = 0$
t <sub>rr</sub>	_	350	_	ns	$I_F = 8 \text{ A}, V_{GS} = 0,$ $di_F/dt = 100 \text{ A}/\mu\text{s}$
	V   V   O   O   O   O   O   O   O   O	$\begin{array}{cccccccccccccccccccccccccccccccccccc$	$\begin{array}{cccccccccccccccccccccccccccccccccccc$	$\begin{array}{cccccccccccccccccccccccccccccccccccc$	$\begin{array}{cccccccccccccccccccccccccccccccccccc$

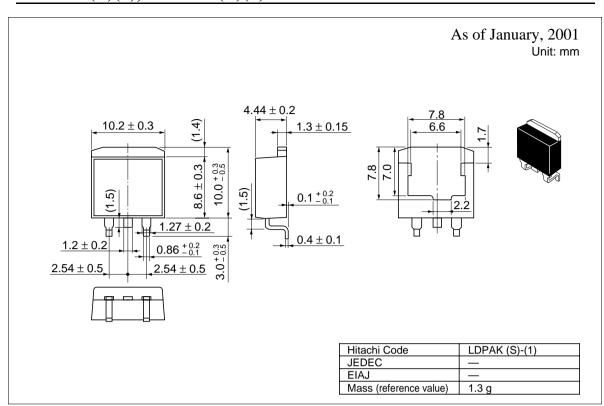
Note: 1. Pulse test

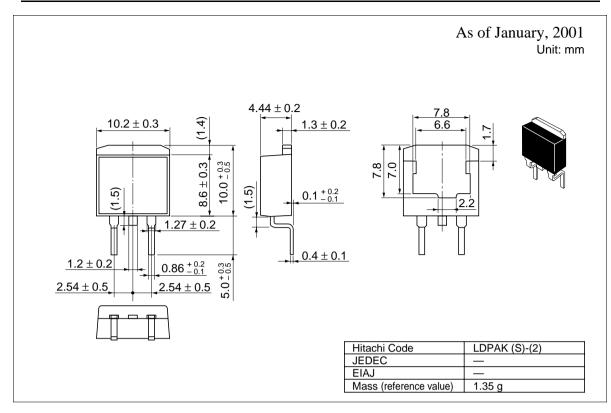
See characteristic curves of 2SK1159, 2SK1160.



## **Package Dimensions**







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